

[Handwritten signature]

A cross-sectional view of a substrate assembly 20. The assembly consists of a substrate 22 with a top surface. A thin layer 24 is disposed on the top surface of the substrate 22. A layer 26 is disposed on top of layer 24. A top layer 28 is disposed on top of layer 26. The top layer 28 is shown with a hatched pattern. The substrate 22 is shown with a break symbol at the bottom.

A cross-sectional view of a substrate assembly 20. The assembly consists of a substrate 22 with a top layer 24. A central layer 26 is embedded within the top layer 24. A layer 28 is located between the top layer 24 and the central layer 26. A layer 30 is located between the central layer 26 and the top layer 24. A layer 32 is located between the central layer 26 and the top layer 24. The top layer 24 and the central layer 26 are shown with a hatched pattern. The substrate 22 is shown with a solid pattern. The layers 28 and 30 are shown with a solid pattern. The layers 32 and 26 are shown with a hatched pattern. The assembly is shown with a cross-section of the substrate 22 and the top layer 24. The central layer 26 is embedded within the top layer 24. The layer 28 is located between the top layer 24 and the central layer 26. The layer 30 is located between the central layer 26 and the top layer 24. The layer 32 is located between the central layer 26 and the top layer 24. The top layer 24 and the central layer 26 are shown with a hatched pattern. The substrate 22 is shown with a solid pattern. The layers 28 and 30 are shown with a solid pattern. The layers 32 and 26 are shown with a hatched pattern.

FIG. 3
(PRIOR ART)

Also

[illegible]

2/4

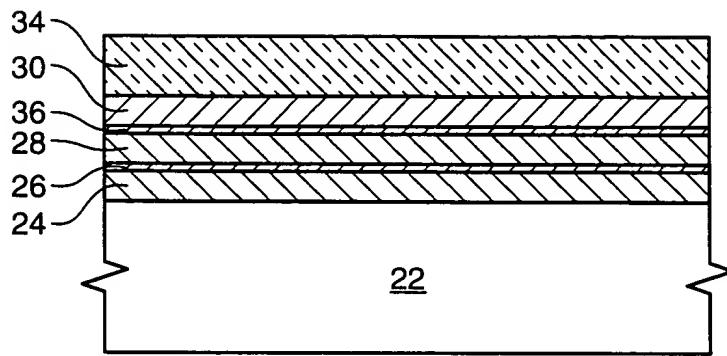


FIG. 4

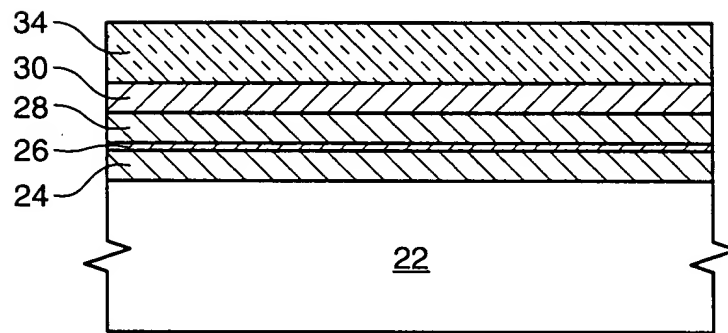


FIG. 5

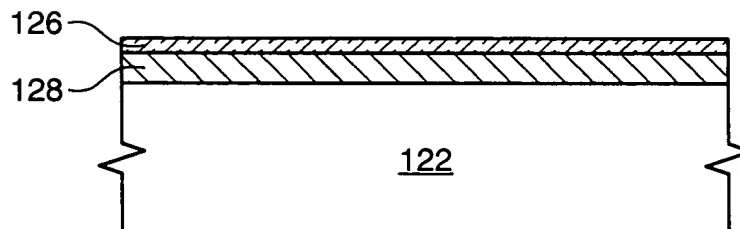


FIG. 6
(PRIOR ART)

007680-21825960



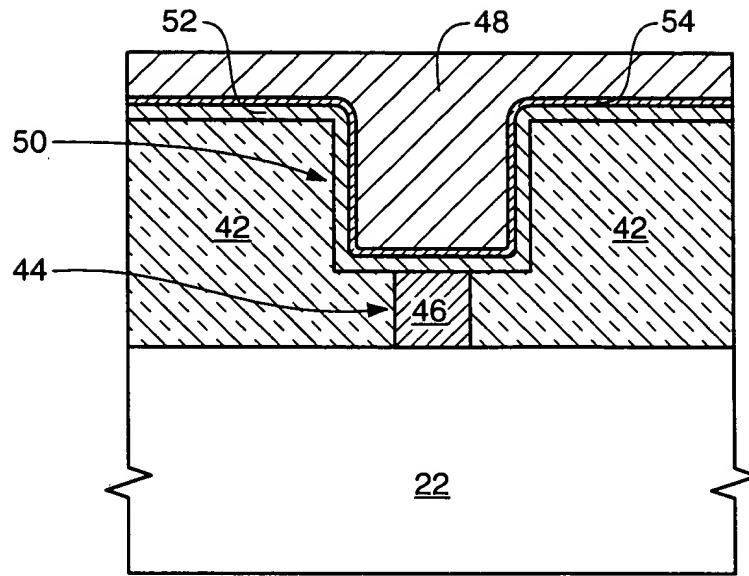


FIG. 9

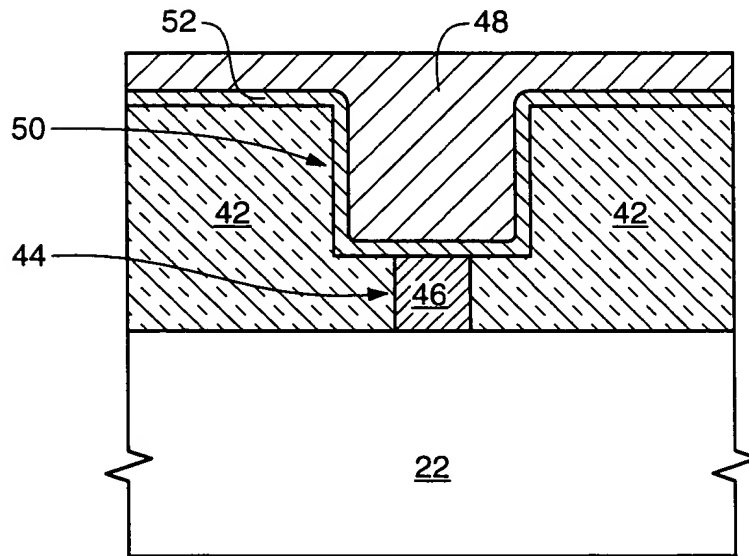


FIG. 10

20250121 21:25:00